TechnoBusiness Forum -- 2005 Open Innovation -- Enterprise Transformation --



Nanotechnology Cross-Industry Focus Diran Apelian – Worcester Polytechnique Institute & Director the Metals and Materials Sloan Center

Worcester Polytechnic Institute





METAL PROCESSING INSTITUTE

www.wpi.edu/+mpi

Georgia Institute of Paper Science Tech and Technology

Metal Processing Institute

- Advanced Casting Research Center
- Center for Heat Treating Excellence
- M. Boorky Powder Metallurgy Center
- Sloan Industry Studies (PMRC)

Metal Processing Institute

An industry-university alliance with 110 corporate partners dedicated to advance the frontiers of net shape manufacturing through knowledge creation and dissemination, and through education.

Materials Science and Engineering -- HISTORICAL PERSPECTIVE

- Evolved from mining departments; Mineral engineering heritage – 1860's / Utah, Rockies, etc.
- 1860's.... steel production: 20,000 tons/year
- Bessemer (1864), Open-Hearth process (1880)
- 1880's iron ore deposits Missouri, Lake Superior
- By late 1890's, steel production: 22 million tons
- Railroad mania... Bridges, infrastructure, etc.
- Construction with steel framework in 1890



HISTORICAL PERSPECTIVE - continued

- Birth of structure-processing-property-performance
- Electric generators 1860's
- Carbon filament electric light bulb 1879
- Graham Bell invention of the telephone (1876)
- Availability of electrical energy: Al production (1888)
- 1900-1930.... New processes, exploding civilian markets, autos 15 million model Ts were produced between 1908-1927 vacuum cleaners, electric iron, washing machine
- Aircraft production ... 1935 Douglas DC3
- 1929 production: steel 62 million tons/year & AI 114,000 tons/year (3K in 1900)

HISTORICAL PERSPECTIVE - continued

MARKET NEEDS – STRENGTH, RELIABILTY, PERFORMANCE

- Superalloys (1947); WWII Ti, U, Be, Pl
- First dislocations observed 1950
- Teflon 1950
- Polycarbonate 1953
- High Density Polyethylene 1955
- Transistor 1948

- Integrated circuit 1958
- 1959 DARPA... Interdisciplinary Research centers in Materials... a seminal initiative!
- 1970's IC more than 10,000 components per chip
- Kevlar mid 70's
- Composite materials

SHIFT FROM STRUCTURAL MATERIALS TO FUNCTIONAL MATERIALS





Source: Nexus: MST Market study, 1996 - 2002



Microelectromechanical systems: applications

What are MEMS ?

MicroElectroMechanical Systems (MEMS) is a revolutionary enabling technology that merges the functions of

> sensing actuation and controls with computation and communication collocated on a chip



In some cases ...

duplicates MOTHER NATURE

to affect the way people and machines interact with the physical world, and does so in very small sizes using very low power for operations in multi environments



APPLICATIONS OF MEMS

Inertial navigation units on a chip for package guidance and personal navigation

<u>Electromechanical signal processing</u> for ultra- small, ultra low- power wireless communication

<u>Distributed unattended sensors</u> for asset tracking, <u>environmental monitoring</u>, security surveillance

<u>Integrated fluidic systems</u> for miniature analytical instruments, propellant, and combustion control

<u>Embedded sensors and actuators</u> for condition- based maintenance

Mass data storage devices for high density, low power

Integrated micro- optomechanical components for displays and fiber- optic switches

<u>Active, conformable surfaces</u> for distributed aerodynamic control of aircraft and adaptive optics











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Microelectronics: RF MEMS



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Use AFIM-like cantilevers to detect target molecules in gases and liquids

Detect contaminants in water and air Detect presence of specific biomolecules for research and medicine

Detect biochemical metabolites

Detect explosives and toxic gases

As an artificial nose, study aromas and flavors

Measure surface stress during thin film deposition

212 2 201

Cantilever Tool

SANDIA 1,000,000 rpm microengine



SANDIA 1,000,000 rpm microengine



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MEMS optical interconnection Typical application of a microengine



INTERCONNECTION CONCEPT





μ-ENGINE ACTUATED μ-MIRROR DEVICE

DEVICE DETAILS

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SCALE

 MEMS greater than 100 nm

 NEMS Nano-electromechanical systems Less than 100 nm

 Nanostructured components and materials Less than 60 nm



Source: Steve Jurvetson, Draper Fisher Jurvetson



Ni nanodot array



GaAs nanopillar array



0.2 0.4 0.6 0.8 JM 0.0 nm

GaN nanopore array



Carbon nanotube array

InAs nanodot array





An array of 30 nm diameter Co dots with period of 50 nm; inset shows a block copolymer film selfassembled on a substrate with periodic grooves, providing the pattern with long-range order *Top and bottom views of a nanopore array (45 nm pore size) produced by anodization*

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Anodization process and a periodic array of high aspect ratio aligned carbon nanotubes





Courtesy: Prof. J. Xu – Brown University

Solution-Precursor Plasma Spray (SPPS) Process









Fine uniform grains (~20-30 nm) in electrodeposited Ni



Crystallinity extending to the boundary and absence of any second phase at the boundary

A complex non-metallic component that has been successfully coated with a nanocrystalline metal by electrodeposition



Courtesy: Prof. S. Kumar – Brown U. & Integran website; <u>www.integran.com</u>



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The Role of Paper Micro-Nano Structures on Commercial Paper Printability

o PI: Nikolas Provatas

Associate Professor in Materials Science and Engineering, McMaster University 2002-

- o Education
 - Ph.D. McGill University, Condensed Matter Physics - 1994
- o Work Experience
 - Research Fellow University of Helsinki random fibre networks and paper structure modelling –1994-1996.
 - Research Associate University of Illinois at Urbana-Champaign – solidification microstructure modelling -1996-1999. Research Scientist –Pulp and Paper Research Institute of Canada –1999-2002



Virtual Paper Microstructures and Impact Printing

Uncalendered Paper Surface



Surface roughness \rightarrow source of print density (mottle) in commercial paper

Virtual Paper Microstructures and Xerographic Printing

Electrostatic field variation

Digitized paper cross-section (by SEM)



00:00:00 1900000 1 of 1 Sunday

3D electrostatic potential variation

New 3D parallel, Multi-Grid code computes local (nanometer-micrometer) variations of electrostatic transfer forces on xerographic toner from virtual or experimental paper maps



Paper thickness & mass variations \rightarrow source of electrostatic transfer forces



Figure 1. Publications over time by material topic.

Table I: Correlation of Publications to Economic Activity.

Topic	2004 Papers	2004 Revenue (\$ Billions)	2004 Ratio (paper/\$1B revenue)	Growth	2010 Revenue (\$ Billions)	2010 Ratio (paper/\$1B revenue)
Silicon	14,185	160	88.7	10%	290	49
III-V	1300	13	100.0	17%	33	39
Steel	5354	205	26.1	3%	245	22
Nitrides	1200	2.5	480.0	47%	25	48
Nano	30,828	?	?	?	?	?

Source: MRS

Federal Support of Research, FY 1970 - 2004

